

Dual common source NPT IGBT Power Module

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$V_{CES} = 1200V$ $I_{C} = 100A$ @ Tc = 80°C

Application

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

Features

- Non Punch Through (NPT) Fast IGBT
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 50 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated
 - Kelvin emitter for easy drive
 - Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
 - Internal thermistor for temperature monitoring

• High level of integration

Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Easy paralleling due to positive TC of VCEsat
- Low profile
- RoHS compliant

Absolute maximum ratings

| Symbol | Parameter | | Max ratings | Unit | |
|------------------|---------------------------------------|------------------------|--------------|------|--|
| V _{CES} | Collector - Emitter Breakdown Voltage | | 1200 | V | |
| т | Continuous Collector Current | $T_c = 25^{\circ}C$ | 135 | | |
| I _C | Continuous Collector Current | $T_c = 80^{\circ}C$ | 100 | А | |
| I _{CM} | Pulsed Collector Current | $T_c = 25^{\circ}C$ | 300 | | |
| V _{GE} | Gate – Emitter Voltage | | ±20 | V | |
| PD | Maximum Power Dissipation | $T_c = 25^{\circ}C$ | 568 | W | |
| RBSOA | Reverse Bias Safe Operating Area | $T_{j} = 150^{\circ}C$ | 200A @ 1200V | | |
| | | | | | |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

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All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Тур | Max | Unit |
|----------------------|--------------------------------------|--|------------------------|-----|-----|-----|------|
| Т | Zero Gate Voltage Collector Current | $V_{GE} = 0V$ | $T_i = 25^{\circ}C$ | | | 350 | μA |
| I _{CES} | Zero Gate Voltage Collector Current | $V_{CE} = 1200V$ | $T_{i} = 125^{\circ}C$ | | | 600 | μΑ |
| N/ | Callester Emitter Seturation Valtere | $V_{GE} = 15V$ | $T_j = 25^{\circ}C$ | | 3.2 | 3.7 | N/ |
| V _{CE(sat)} | Collector Emitter Saturation Voltage | $I_{\rm C} = 100 {\rm A}$ | $T_{j} = 125^{\circ}C$ | | 4.0 | | v |
| V _{GE(th)} | Gate Threshold Voltage | $V_{GE} = V_{CE}$, $I_C = 2 \text{ mA}$ | | 4.5 | | 6.5 | V |
| I _{GES} | Gate – Emitter Leakage Current | $V_{GE} = 20 V, V_{CE} = 0V$ | | | | 150 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Тур | Max | Unit |
|---------------------|------------------------------|---|----------------------|-----|------|-----|------|
| Cies | Input Capacitance | $V_{GE} = 0V$ $V_{CE} = 25V$ $f = 1MHz$ | | | 6900 | | |
| C _{oes} | Output Capacitance | | | | 660 | | pF |
| C _{res} | Reverse Transfer Capacitance | | | | 440 | | |
| Qg | Total gate Charge | $V_{GS} = 15V$ | | | 660 | | |
| Q _{ge} | Gate – Emitter Charge | $V_{Bus} = 600V$ | | | 70 | | nC |
| Q _{gc} | Gate – Collector Charge | $I_{\rm C} = 100 {\rm A}$ | | | 400 | | |
| T _{d(on)} | Turn-on Delay Time | Inductive Switch | | 35 | | | |
| Tr | Rise Time | $V_{GE} = 15V$ | | | 65 | | |
| T _{d(off)} | Turn-off Delay Time | $V_{Bus} = 600V$ $I_{C} = 100A$ $R_{G} = 2.5 \ \Omega$ | | | 320 | | ns |
| T _f | Fall Time | | | | 30 | | |
| T _{d(on)} | Turn-on Delay Time | Inductive Switch | ing (125°C) | | 35 | | |
| Tr | Rise Time | $V_{GE} = 15V$ $V_{Bus} = 600V$ $I_{C} = 100A$ $R_{G} = 2.5 \Omega$ | | | 65 | | |
| T _{d(off)} | Turn-off Delay Time | | | | 360 | | ns |
| $T_{\rm f}$ | Fall Time | | | | 40 | | |
| Eon | Turn-on Switching Energy | $V_{GE} = 15V$ $V_{Bus} = 600V$ | $T_j = 125^{\circ}C$ | | 13.9 | | T |
| E _{off} | Turn-off Switching Energy | $I_{\rm C} = 100 \text{A}$ $R_{\rm G} = 2.5 \ \Omega$ | $T_j = 125^{\circ}C$ | | 6.1 | | mJ |

Reverse diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | | Min | Тур | Max | Unit |
|------------------|---|---|----------------------|------|------|-----|------|
| V _{RRM} | Maximum Peak Repetitive Reverse Voltage | | | 1200 | | | V |
| I _{RM} | Maximum Reverse Leakage Current | V _R =1200V | $T_j = 25^{\circ}C$ | | | 350 | μA |
| IRM | Waxinium Reverse Leakage Current | v _R -1200v | $T_j = 125^{\circ}C$ | | | 600 | μА |
| I _F | DC Forward Current | | $Tc = 70^{\circ}C$ | | 120 | | А |
| | Diode Forward Voltage | $I_{\rm F} = 120 {\rm A}$ | | | 2.0 | 2.5 | |
| V _F | | $I_F = 240A$ | | | 2.3 | | V |
| | | $I_{\rm F} = 120 {\rm A}$ | $T_j = 125^{\circ}C$ | | 1.8 | | |
| t | Reverse Recovery Time | $I_{\rm F} = 120 A$ $V_{\rm R} = 800 V$ | $T_j = 25^{\circ}C$ | | 370 | | na |
| t _{rr} | | | $T_j = 125^{\circ}C$ | | 500 | | ns |
| Q _{rr} | Reverse Recovery Charge | $di/dt = 800 \text{A}/\mu\text{s}$ | $T_j = 25^{\circ}C$ | | 2.64 | | μC |
| | | | $T_j = 125^{\circ}C$ | | 13.8 | | μυ |



Thermal and package characteristics

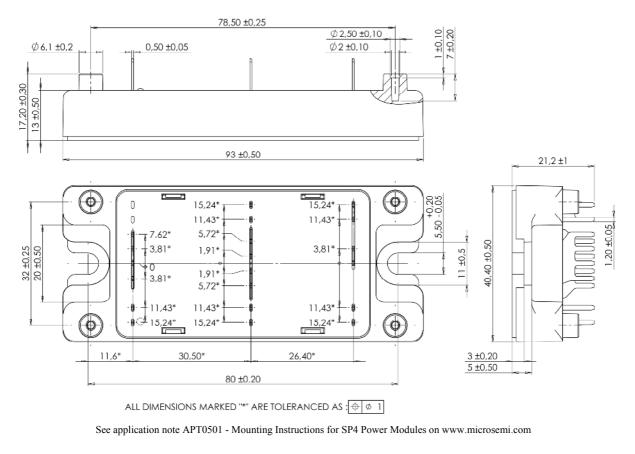
| Symbol | Characteristic | | | Min | Тур | Max | Unit |
|---------------------------|---|-------------|------|------|------|------|------|
| R _{thJC} | Junction to Case Thermal Resistance | | IGBT | | | 0.22 | °C/W |
| R _{th} JC | | Diode | | | 0.32 | C/ W | |
| V _{ISOL} | RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz | | | 4000 | | | V |
| TJ | Operating junction temperature range | | | -40 | | 150 | |
| T _{STG} | Storage Temperature Range | | -40 | | 125 | °C | |
| T _C | Operating Case Temperature -40 100 | | | | | | |
| Torque | Mounting torque | To heatsink | M5 | 2.5 | | 4.7 | N.m |
| Wt | Package Weight | | | | | 160 | g |

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol | Characteristic | Min | Тур | Max | Unit |
|-----------------|-----------------------------|-----|------|-----|------|
| R ₂₅ | Resistance @ 25°C | | 50 | | kΩ |
| B 25/85 | $T_{25} = 298.15 \text{ K}$ | | 3952 | | K |
| | D | | | | |

$$R_{T} = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$
 T: Thermistor temperature
R_T: Thermistor value at T

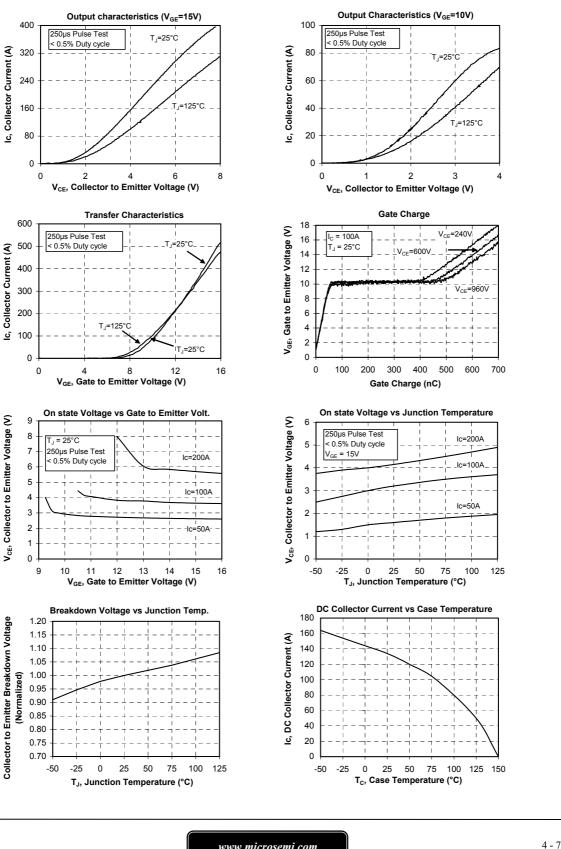
SP4 Package outline (dimensions in mm)



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Typical Performance Curve



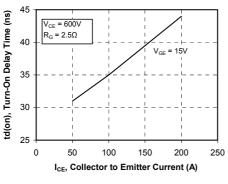
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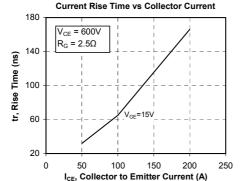
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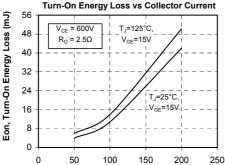
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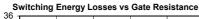
Turn-On Delay Time vs Collector Current

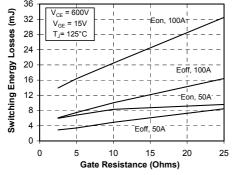




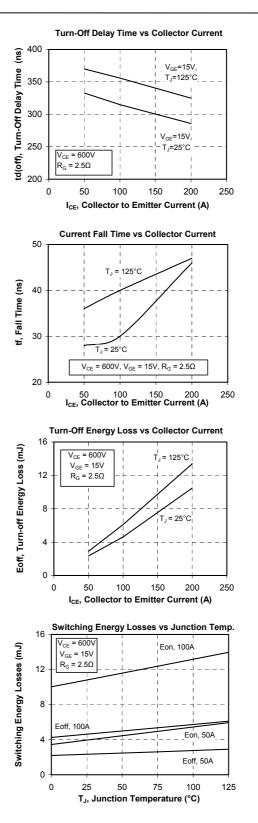


I_{CE}, Collector to Emitter Current (A)

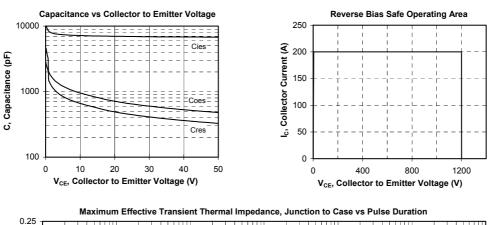


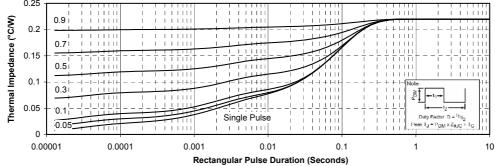


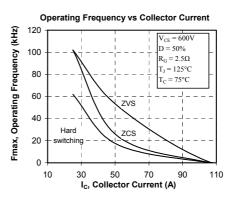
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